P.TO-1449

Information Declosure Citation in an Application

Application No. 10/042,914 Applicant(s) Malcolm M. Smith, et al.

Docket Number Group Art Unit Filing Date January 8, 2002

			U.S	PATENT DOCUMENTS	<u></u>	т	
		DOCUMENT NO.	DATE	NAME	CLASS	SUBCLASS	FILING DATE
m	A	2002/0059114	05/16/2002	Cockrill et al.	705	27	11/29/1998
m	В	4,747,096	05/24/1988	Piasecki et al.	370	81	04/17/1986
an	С	4,860,313	08/22/1989	Shpiro	375	27	09/21/1987
hn	D	5,117,453	05/26/1992	Piasecki et al.	379	100	12/18/1989
m	E	5,497,505	03/05/1996	Koohgoli et al.	455	34.1	12/17/1993
on	F	5,894,557	04/13/1999	Bade et al.	395	200.58	03/29/1996
In	G	5,905,736	05/18/1999	Ronen et al.	370	546	04/22/1996
100	Н	5,956,391	09/21/1999	Melen et al.	379	114	02/10/1997
an	1	5,970,477	10/19/1999	Roden	705	32	07/15/1996
20	J	6,047,051	04/04/2000	Ginzboorg et al.	379	130	06/24/1997
nn	К	6,134,245	10/17/2000	Scarmalis	370	474	01/09/1998
In	L	6,192,051	02/20/2001	Lipman et al.	370	389	02/26/1999
In	M	6,363,065	03/26/2002	Thornton et al.	370	352	11/10/1999
un	N	6,400,722	06/04/2002	Chuah et al.	370	401	08/24/1998
m	0	6,424,940	07/23/2002	Agassy et al.	704	219	02/25/2000
m	Р	6,477,595	11/05/2002	Cohen et al.	710	105	04/11/2000
10	Q	6,512,754	01/28/2003	Feder et al.	370	338	08/24/1998
	R	6,512,773	01/28/2003	Scott	370	395.61	12/30/1998
In	S	6,512,790	01/28/2003	Sourani	375	240	12/17/1999
W'		J	FORE	IGN PATENT DOCUMEN	ITS		
TPANSI ATION							

U.S. PATENT DOCUMENTS

TRANSLATION SUBCLASS YES **CLASS** COUNTRY DOCUMENT NO. DATE G07F 7/10  $\overline{\mathsf{x}}$ PCT WO 98/26381 12.12.1997 G06F 17/60 X 15.12.1998 PCT WO 99/31610 11/04  $\overline{\mathsf{X}}$ PCT H04Q WO 99/35875 15.07.1999 7/30 X H04Q 26.10.2000 PCT WO 00/64204

NON-PATENT DOCUMENTS

DOCUMENT (Including Author, Title, Source, and Pertinent Pages)

X

Y

Z

**EXAMINER** 

DATE CONSIDERED
3/9/06

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP § 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to the applicant.